I. SCOPE :

This specification applies to the Pb Free high current type SMD inductors for

MSI-110810-SERIES

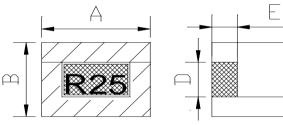
PRODUCT INDENTIFICATION

<u>MSI-110810- R25 M</u>

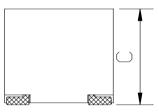
1 2 3 4

- ① Product Code
- ② Dimensions Code
- ③ Inductance Code
- ④ Tolerance Code

(1) SHAPES AND DIMENSIONS



A: 10.7 Max.	mm
B: 7.5 Max.	mm
C: 9.5 Max.	mm
D: 2.8±0.2	mm
E: 2.8±0.3	mm



(2) ELECTRICAL SPECIFICATIONS SEE TABLE 1

TEST INSTRUMENTS

L : HP 4284A PRECISION LCR METER (or equivalent) RDC : CHROMA MODEL 16502 MILLIOHMMETER (or equivalent) IDC1 :WK3255B+3265B (or equivalent)

(3) CHARACTERISTICS

(3)-1 Operate temperature range $-40^{\circ}C \sim +125^{\circ}C$ (Including self temp. rise)

(3)-2 Storage temperature range $-40^{\circ}C \sim +125^{\circ}C$



TABLE

MAGLAYERS	Inductance	Percent	nt Test Resistance Rated DC Current		Marking		
PT/NO.	L(µH)	Tolerance	Frequency	RDC(mΩ)	IDC1(A)	IDC2(A)	Warking
MSI-110810-R22	0.22	L,M	100kHz/1.0V	0.22 ±7%	60	45	R22
MSI-110810-R25	0.25	K,L,M	100kHz/1.0V	0.22 ±7%	50	45	R25
MSI-110810-R32	0.32	K,L,M	100kHz/1.0V	0.22 ±7%	40	45	R32
MSI-110810-R40	0.40	L,M	100kHz/1.0V	0.22 ±7%	36	45	R40

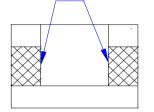
% □ specify the inductance tolerance,K(±10%),L(±15%),M(±20%)

% IDC1 : Based on inductance change (\triangle L/Lo : drop 20% Typ.)@ ambient temp. 25 $^{\circ}$ C

IDC2 : Based on temperature rise ($\triangle T$: 40°C TYP.)

Rated DC Current : The less value which is IDC1 or IDC2 .

RDC Measure point



Bottom view



(4) RELIABILITY TEST METHOD

MECHANICAL

TEST ITEM	SPECIFICATION	TEST DETAILS
Substrate bending	∆L/Lo≦±5%	The sample shall be soldered onto the printed circuit board
		in figure 1 and a load applied unitil the figure in the arrow
	There shall be	direction is made approximately 3mm.(keep time 30 seconds)
	no mechanical	PCB dimension shall the page 7/9
	damage or elec-	F(Pressurization)
	trical damege.	
		R5 45±2 45±2 10 R340
		PRESSURE ROD figure-1
Vibration	∆L/Lo≦±5%	The sample shall be soldered onto the printed circuit board
		and when a vibration having an amplitude of 1.52mm
	There shall be	and a frequency of from 10 to 55Hz/1 minute repeated should
	no mechanical	be applied to the 3 directions (X,Y,Z) for 2 hours each.
	damage.	(A total of 6 hours)
	New solder	Flux (reain isopropul clock of (US K 4522)) shall be sected
Solderability	More than 90%	Flux (rosin, isopropyl alcohol{JIS-K-1522}) shall be coated over the whole of the sample before hard, the sample shall
		then be preheated for about 2 minutes in a temperature of
		$130 \sim 150^{\circ}$ and after it has been immersed to a depth 0.5mm
		below for 3±0.2 seconds fully in molten solder M705 with
		a temperature of 245±5℃.
		More than 90% of the electrode sections shall be couered
		with new solder smoothly when the sample is taken out of
		the solder bath.



MECHANICAL

TEST ITEM		SPECIFICATION			
Resistance to	There shall be	Temperature profile of reflow soldering			
Soldering heat	no damage or				
(reflow soldering)	problems.	The specimen shall be passed through the reflow oven with the condition shown in the above profile for 1 time. The specimen shall be stored at standard atmospheric conditions for 1 hour, after which the measurement shall be made.			

ELECTRICAL

TEST ITEM	SPECIFICATION	TEST DETAILS
Temperature	∆L/L20℃≦±10%	The test shall be performed after the sample has stabilized in
characteristics	0~2000 ppm/℃	an ambient temperature of -20 to +85 $^\circ\!\mathrm{C}$,and the value
		calculated based on the value applicable in a normal
		temperature and narmal humidity shall be $ riangle L/L20^\circ\!C \leq \pm 10\%$.



ENVIROMENT CHARACTERISTICS

TEST ITEM				SPECIFICATION		
High temperature	∆L/Lo≦±5%	The san	nple s	hall be left for 96±4 hou	rs in an atmospere wi	ith
storage		a temperature of 125 $^{\circ}\!\mathrm{C}$ and a normal humidity.				
	There shall be	Upon co	Upon completion of the measurement shall be made after the			
	no mechanical	sample	has b	een left in a normal tem	perature and normal	
	damage.	humidit	humidity for 1 hour.			
Low temperature	∆L/Lo≦±5%	The san	The sample shall be left for 96±4 hours in an atmosphere with			
storage		a tempe	a temperature of -25±3 $^\circ$ C.			
	There shall be	Upon co	Upon completion of the test, the measurement shall be made			
	no mechanical	after the	after the sample has been left in a normal temperature and			
	damage.	normal	normal humidity for 1 hour.			
Change of	∆L/Lo≦±5%	The san	nple s	hall be subject to 5 cont	tinuos cycles, such a	s shown
temperature		in the ta	in the table 2 below and then it shall be subjected to standard			
	There shall be	stmospheric conditions for 1 hour, after which measurement				
	no other dama-	shall be made.				
	ge of problems					
			table 2			
				Temperature	Duration	
			1	−25±3 ℃	30 min	
			'	(Themostat No.1)	30 min.	
			2	Standard		
			-	atmospheric	No.1→No.2	
			3	85±2℃	30 min.	
				(Themostat No.2)	30 min.	
			4	Standard	No 2 - No 4	
			-	atmospheric	No.2→No.1	
Moisture storage		The ser	anla a		re in a tomporature of	:
woisture storage	∆L/Lo≦±5%		The sample shall be left for 96 ± 4 hours in a temperature of			
	There shall be	$40\pm 2^{\circ}$ and a humidity(RH) of $90 \sim 95\%$.				
		Upon completion of the test, the measurement shall be made				
	no mechanical	after the sample has been left in a normal temperature and normal humidity more than 1 hour.				
	damage.	normal	numi	aity more than 1 hour.		

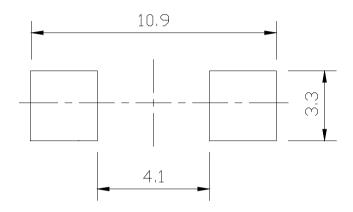


(5) LAND DIMENSION (Ref.)

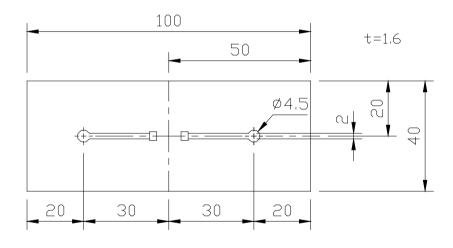
PCB: GLASS EPOXY t=1.6mm

(5)-1 LAND PATTERN DIMENSIONS(mm)

(STANDARD PATTERN)

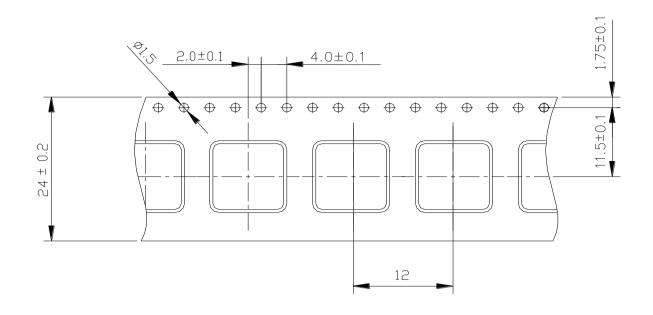


(5)-2 SUBSTRATE BENDING TEST BENDING TEST BOARD



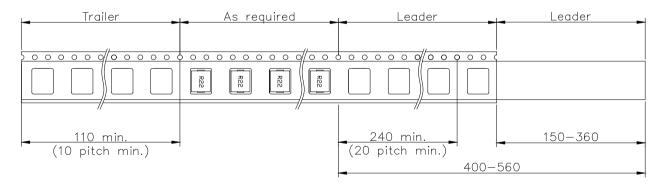


(6) PACKAGING (6)-1 CARRIER TAPE DIMENSIONS (mm)



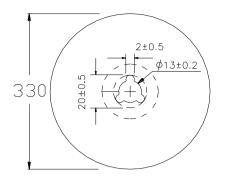
(6)-2 TAPING DIMENSIONS (mm)

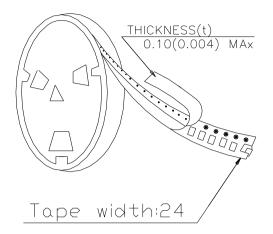






(6)-3 REEL DIMENSIONS (mm)





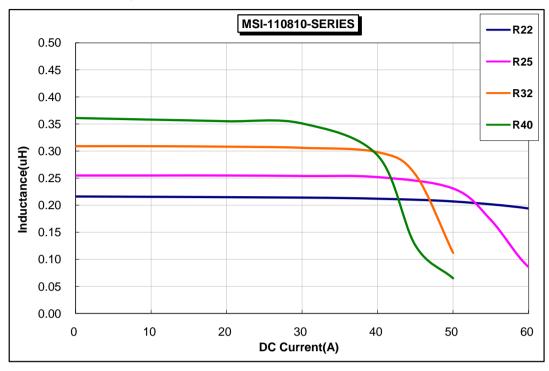
(6)-4 QUANTITY

350pcs/Reel

The products are packaged so that no damage will be sustained.

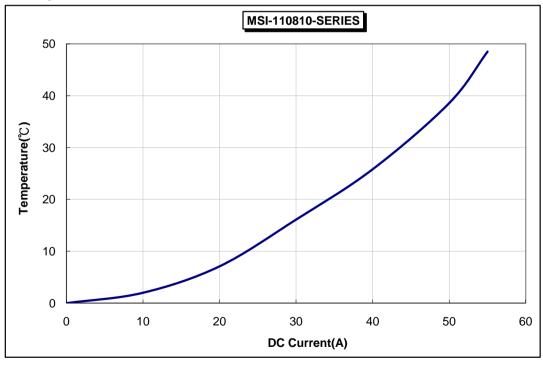


TYPICAL ELECTRICAL CHARACTERISTICS



INDUCTANCE vs. DC CURRENT@100kHz/1.0V Ambient Temperature : 25° C

Temperature Rise vs. DC Current





MSI-110810-SERIES